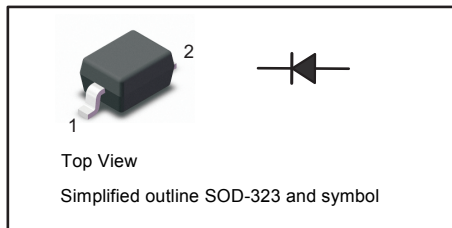


PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode


Features

- ◆ Low Forward Voltage drop
- ◆ Surface mount device

Description

- ◆ High voltage schottky rectifier suited for SLIC
- ◆ protection during the card insertion operation

Absolute Maximum Ratings ($T_a = 25\text{ }^\circ\text{C}$)

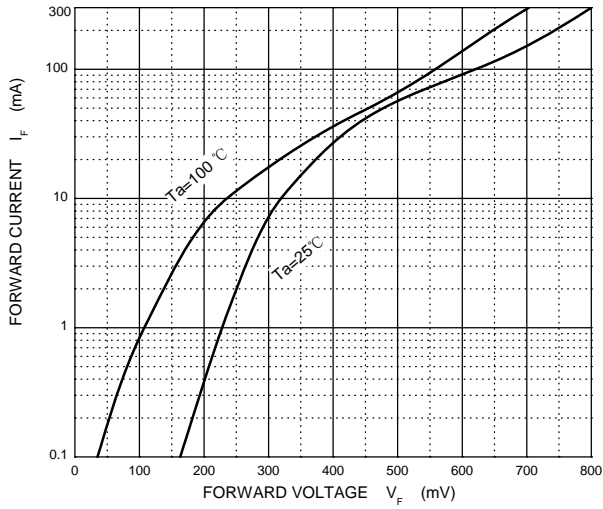
Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Continuous Forward Current	I_F	150	mA
Power Dissipation	P_{tot}	200	mW
Thermal Resistance Junction Ambient	R_{thJA}	500	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 150	$^\circ\text{C}$

Characteristics at $T_a = 25\text{ }^\circ\text{C}$

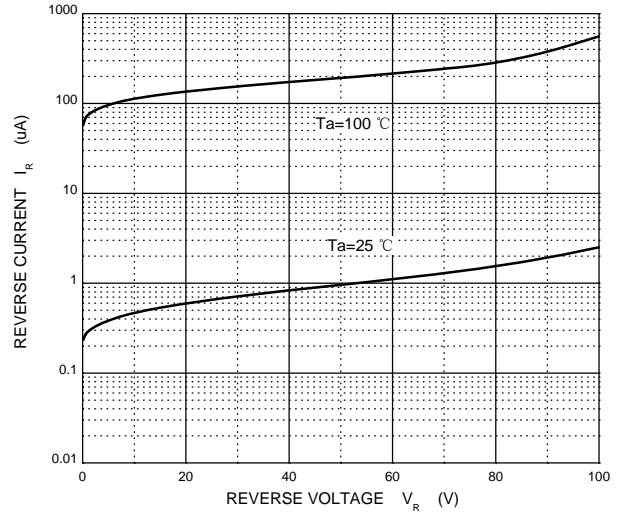
Parameter	Symbol	Min.	Typ.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 100\text{ }\mu\text{A}$	V_{BR}	100	-	-	V
Forward Voltage at $I_F = 0.1\text{ mA}$ at $I_F = 10\text{ mA}$ at $I_F = 250\text{ mA}$	V_F	-	-	0.25 0.45 1	V
Reverse Current at $V_R = 1.5\text{ V}$ at $V_R = 10\text{ V}$ at $V_R = 50\text{ V}$ at $V_R = 75\text{ V}$ at $V_R = 1.5\text{ V}, T_j = 60\text{ }^\circ\text{C}$ at $V_R = 10\text{ V}, T_j = 60\text{ }^\circ\text{C}$ at $V_R = 50\text{ V}, T_j = 60\text{ }^\circ\text{C}$ at $V_R = 75\text{ V}, T_j = 60\text{ }^\circ\text{C}$	I_R	-	-	0.5 0.8 2 5 5 7.5 15 20	μA
Total Capacitance at $V_R = 0\text{ V}, f = 1\text{ MHz}$ at $V_R = 1\text{ V}, f = 1\text{ MHz}$	C_T	-	10 6	-	pF

Typical Characteristics

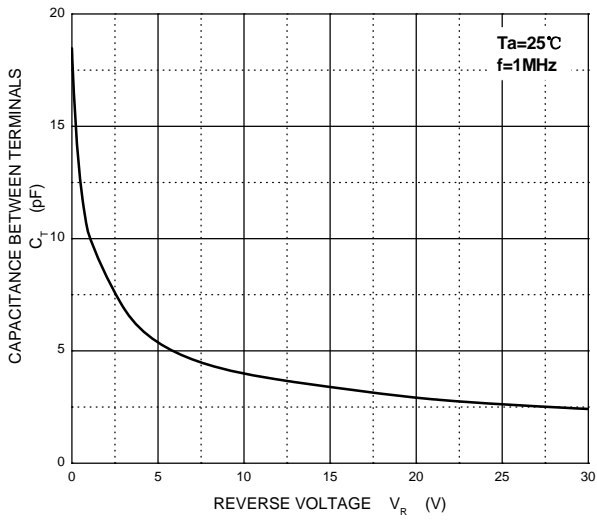
Forward Characteristics



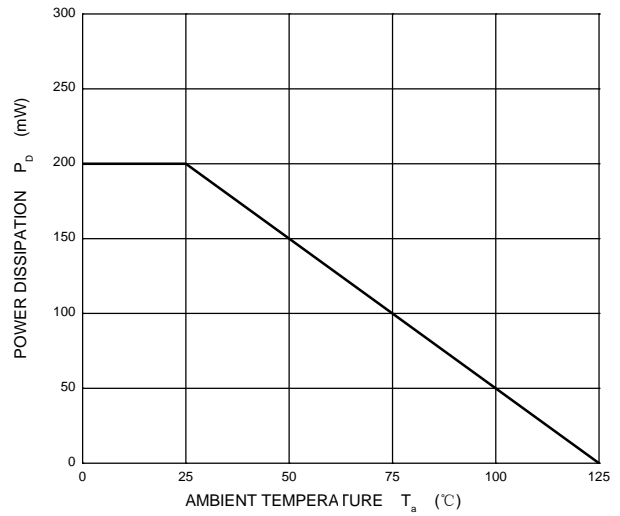
Reverse Characteristics



Capacitance Characteristics



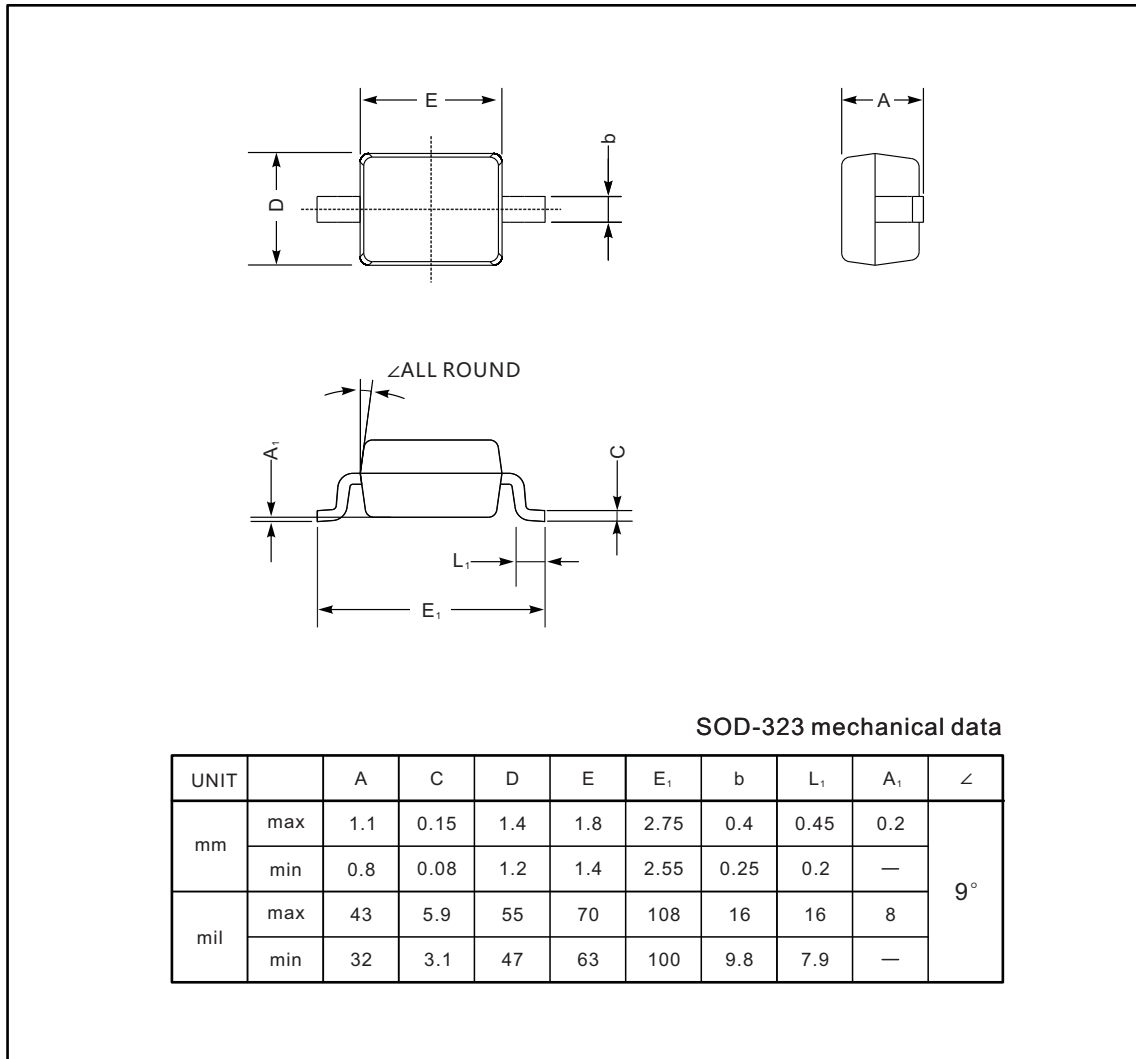
Power Derating Curve



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



The recommended mounting pad size

